

5A, 60V Schottky Barrier Surface Mount Rectifier

FEATURES

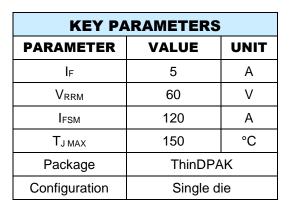
- AEC-Q101 qualified
- Low power loss, high efficiency
- Ideal for automated placement
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

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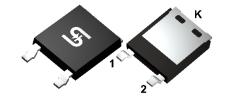
- Low voltage, high frequency, inverter
- DC/DC converter
- Freewheeling diodes
- Reverse battery protection
- Car lighting

MECHANICAL DATA

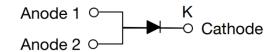
- Case: ThinDPAK
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- · Polarity: As marked
- Weight: 0.196g (approximately)







ThinDPAK



PARAMETER	SYMBOL	MBRAD560H	UNIT	
Marking code on the device		560		
Repetitive peak reverse voltage	V _{RRM}	60	V	
Reverse voltage, total rms value	V _R (RMS)	42	V	
Forward current	lf	5	А	
Surge peak forward current single half	t = 8.3ms		120	А
sine-wave superimposed on rated load	t = 1.0ms	IFSM	260	А
Junction temperature	TJ	-55 to +150	°C	
Storage temperature	T _{STG}	-55 to +150	°C	

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THERMAL PERFORMANCE						
PARAMETER	SYMBOL	TYP	UNIT			
Junction-to-lead thermal resistance(1)	ReJL	2.3	°C/W			
Junction-to-ambient thermal resistance ⁽²⁾	Reja	13.6	°C/W			
Junction-to-case thermal resistance ⁽²⁾	Rejc	3.8	°C/W			

Notes:

- 1. With ideal heat sink
- 2. Units mounted on 2" x 3" x 0.25" Al-plate

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT	
	I _F = 2.5A, T _J = 25°C	VF	0.55	-	V	
Forward voltage(1)	I _F = 5.0A, T _J = 25°C		0.66	0.80	V	
Forward voltage ⁽¹⁾	I _F = 2.5A, T _J = 125°C		0.47	-	V	
	I _F = 5.0A, T _J = 125°C		0.56	0.68	V	
Boyeres surrent @ reted V (2)	T _J = 25°C		-	100	μA	
Reverse current @ rated V _R ⁽²⁾	T _J = 125°C	- I _R	-	20	mA	
Junction capacitance	1MHz, V _R = 4.0V	Сл	244	-	pF	

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION						
ORDERING CODE	PACKAGE	PACKING				
MBRAD560H	ThinDPAK	4,500 / Tape & Reel				



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

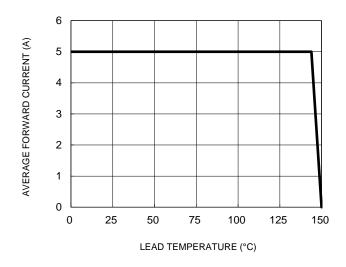


Fig.2 Typical Junction Capacitance

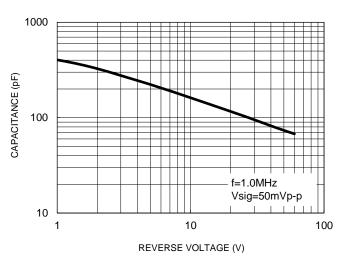
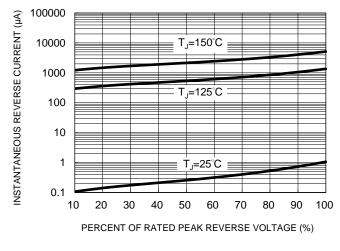


Fig.3 Typical Reverse Characteristics

Fig.4 Typical Forward Characteristics



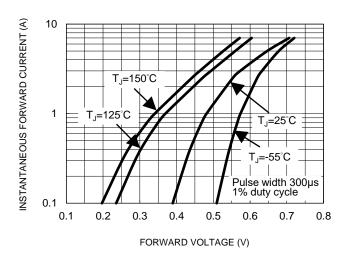
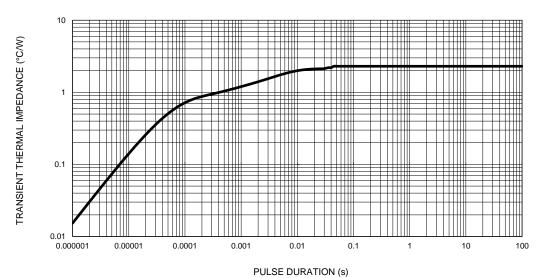


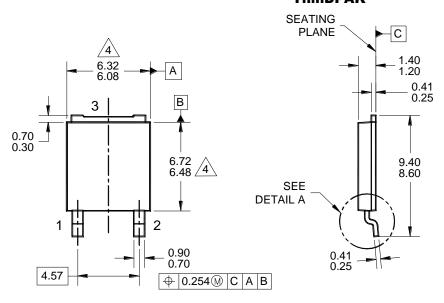
Fig.5 Typical Transient Thermal Impedance

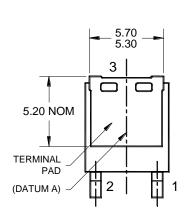


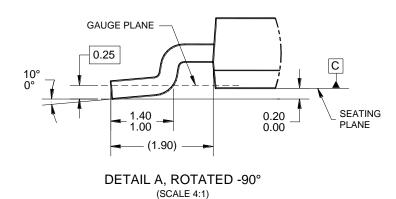


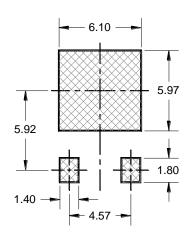
PACKAGE OUTLINE DIMENSIONS

ThinDPAK

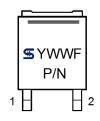








SUGGESTED PAD LAYOUT



MARKING DIAGRAM

YWW = DATE CODE F = FACTORY CODE

P/N = MARKING CODE

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC TO-252, VARIATION AE, ISSUE F.
- MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSION, OR GATE BURRS.
 - 5. DWG NO. REF: HQ2SD07-TDPAK-065 REV A.



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